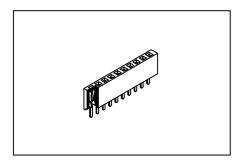
# **GXCON**



Features:

\* Available in Straight.

\* Low profile 7.10mm (0.280").

\* Dual beam contacts offer ultimate performance.

#### Material:

Housing: High temperature housing withstands IR and VPR soldering methods.

Contacts: Phosphor Bronze. Plating: Gold plated over nickel. Tin plated over nickel.

#### **Electrical Characteristics:**

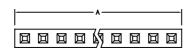
Current Rating: 1 AMP.

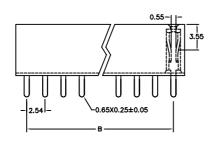
Insulator Resistance:  $5000M\Omega$ min. at DC 500V. Contact Resistance:  $20m\Omega$ max. at DC 100mA. Operating Temperature: -65°C  $\sim +125$ °C.

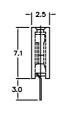
Max Processing Temperature: 230°C for 30~60 seconds.

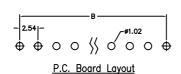
## Mechanical Characteristics:

Insertion Force:140g avg.(0.64mm sq. pin)
Withdrawal Force:114g avg.(0.64mm sq. pin)









Position	3 Thru 40
Dimension	
Α	2.54 X No. of Positions
В	2.54 X No. of Positions -2.54

### Ordering information

<u>PS03-</u> Series Single Row 1: Gold Plated 1: Straight No. of Pin Per Row 2: Tin Plated